

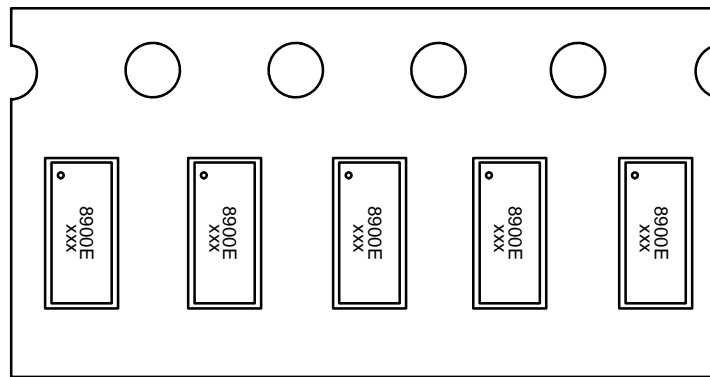


Device Orientation Options for MOSFETs

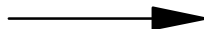
Part Numbers: Si8900EDB

MICRO FOOT® 2X5: 0.8-mm PITCH, 0.275-mm BUMP HEIGHT	
Part Number	Method
Si8900EDB	T2

Device on Tape Orientation



User Direction of Feed



Revision control of this drawing is maintained through Document Control, Pack Specification—PACK-0023-2
ECN: S-50073, Rev. K, 31-Jan-05.